VBM1704

N-Channel 70 V (D-S) MOSFET

FEATURES

175 °C Junction Temperature
TrenchFET[®] Power MOSFET

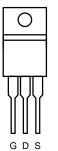
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S N-Channel MOSFET

PRODUCT	SUMMARY	
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)
70	0.004 at V _{GS} = 10 V	120
10	0.007 at V _{GS} = 7.5 V	95

TO-220AB



Parameter		Symbol	Limit	Unit	
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current (T _J = 175 °C) ^b	T _C = 25 °C	L_	120	-	
	T _C = 100 °C	- ^I D	90		
Pulsed Drain Current		I _{DM}	400	А	
Continuous Source Current (Diode Conduction)		۱ _S	90 ^a	7	
Avalanche Current		I _{AS}	80	7	
Single Avalanche Energy (Duty Cycle \leq 1 %)	L = 0.1 mH	E _{AS}	145	mJ	
Maximum Bower Dissinction	T _C = 25 °C	P	150	w	
Maximum Power Dissipation	T _A = 25 °C	P _D	3.2 ^b , 8.6 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stq}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manimum lungting to Ambiggi	$t \le 10 \text{ sec}$	R _{thJA}	15	18	
Maximum Junction-to-Ambient ^a	Steady State NthJA 40 50 °C/W	°C/W			
Maximum Junction-to-Case		R _{thJC}	0.85	1.1	

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t \leq 10 s.





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Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static	1						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	70	75		V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2		4	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		V _{DS} = 70 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 70 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$			50	μA	
		$V_{DS} = 70 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 \text{ °C}$			250	μΑ Α Ω S	
On-State Drain Current ^b	I _{D(on)}	$V_{DS} = 5 V, V_{GS} = 10 V$	90			А	
		V _{GS} = 10 V, I _D = 20 A		0.004			
	Б	V _{GS} = 10 V, I _D = 25 A, T _J = 125 °C		0.009		0	
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 10 V, I _D = 25 A, T _J = 175 °C		0.014		Ω	
		V _{GS} = 7.5 V, I _D = 20 A		0.007		μΑ Α Ω	
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 25 A		60		S	
Dynamic					L		
Input Capacitance	C _{iss}			5150			
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 35 V, f = 1 MHz		530		pF	
Reverse Transfer Capacitance	C _{rss}			275			
Total Gate Charge ^c	Qg			52	78		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 35 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 50 \text{ A}$		13		nC	
Gate-Drain Charge ^c	Q _{gd}			15]	
Turn-On Delay Time ^c	t _{d(on)}			12	23		
Rise Time ^c	t _r	V_{DD} = 35 V, R_L = 0.6 Ω		17	28		
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_\text{D}\cong$ 50 A, V_GEN = 10 V, R_g = 2.5 Ω		38	52	ns	
Fall Time ^c	t _f			21	32	1	
Source-Drain Diode Ratings and Cha	aracteristics (T _C = 25 °C)		•	· ·		
Pulsed Current	I _{SM}				80	А	
Diode Forward Voltage	V _{SD}	I _F = 20 A, V _{GS} = 0 V		1	1.5	V	
Reverse Recovery Time	t _{rr}	I _F = 20 A, di/dt = 100 A/μs		45	100	ns	

Notes:

a. For design aid only; not subject to production testing.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

c. Independent of operating temperature.

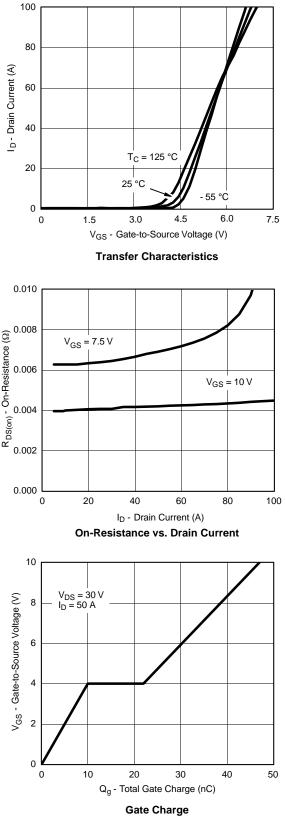
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



V_{GS} = 10 thru 5 V 6 V I_D - Drain Current (A) I_D - Drain Current (A) 4 V, 5 V V_{DS} - Drain-to-Source Voltage (V) **Output Characteristics** 0.010 T_C = - 55 °C R DS(on) - On-Resistance (12) 900'0 800'0 900'0 900'0 g fs - Transconductance (S) 25 °C 125 °C 0.002 0.000 I_D - Drain Current (A) Transconductance V_{GS} - Gate-to-Source Voltage (V) Ciss C - Capacitance (pF) Coss $\mathsf{C}_{\mathsf{rss}}$ V_{DS} - Drain-to-Source Voltage (V)

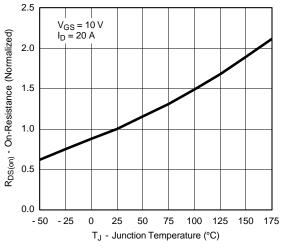
TYPICAL CHARACTERISTICS (25 °C unless noted)

Capacitance

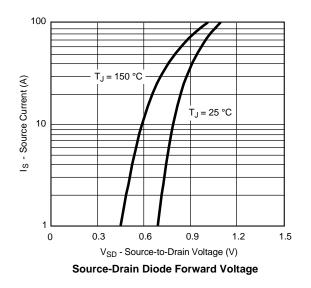




TYPICAL CHARACTERISTICS (25 °C unless noted)

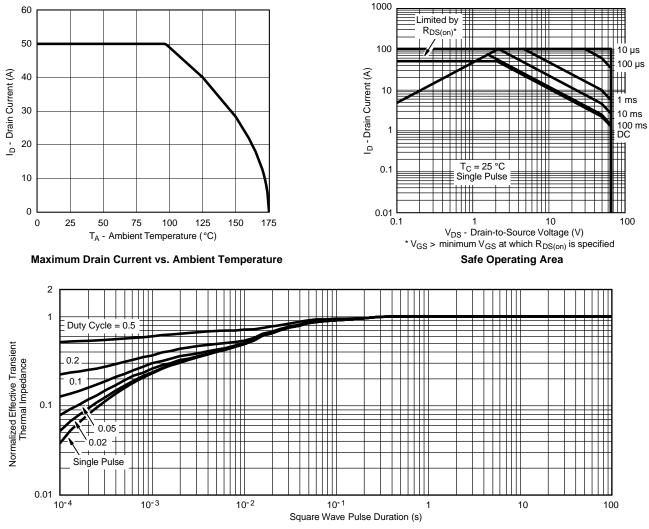


On-Resistance vs. Junction Temperature





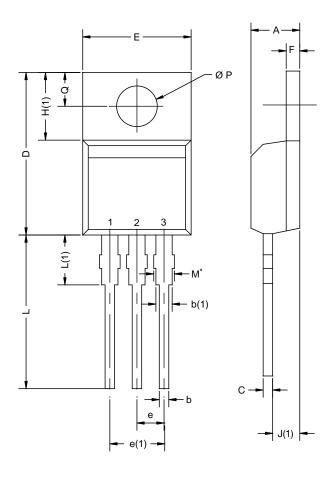
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



TO-220AB



	MILLIN	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.		
А	4.25	4.65	0.167	0.183		
b	0.69	1.01	0.027	0.040		
b(1)	1.20	1.73	0.047	0.068		
С	0.36	0.61	0.014	0.024		
D	14.85	15.49	0.585	0.610		
Е	10.04	10.51	0.395	0.414		
е	2.41	2.67	0.095	0.105		
e(1)	4.88	5.28	0.192	0.208		
F	1.14	1.40	0.045	0.055		
H(1)	6.09	6.48	0.240	0.255		
J(1)	2.41	2.92	0.095	0.115		
L	13.35	14.02	0.526	0.552		
L(1)	3.32	3.82	0.131	0.150		
ØΡ	3.54	3.94	0.139	0.155		
Q	2.60	3.00	0.102	0.118		

Notes

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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